

# BCW30LT1G, SBCW30LT1G

## General Purpose Transistors

### PNP Silicon

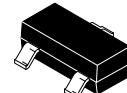
#### Features

- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant\*



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SOT-23 (TO-236)  
CASE 318-08  
STYLE 6

#### MAXIMUM RATINGS

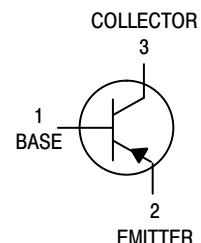
| Rating                         | Symbol    | Value | Unit |
|--------------------------------|-----------|-------|------|
| Collector – Emitter Voltage    | $V_{CEO}$ | -32   | Vdc  |
| Collector – Base Voltage       | $V_{CBO}$ | -32   | Vdc  |
| Emitter-Base Voltage           | $V_{EBO}$ | -5.0  | Vdc  |
| Collector Current – Continuous | $I_C$     | -100  | mAdc |

#### THERMAL CHARACTERISTICS

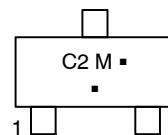
| Characteristic  | Symbol          | Value       | Unit                       |
|---|-----------------|-------------|----------------------------|
| Total Device Dissipation<br>FR-5 Board (Note 1)<br>$T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$        | $P_D$           | 225<br>1.8  | mW<br>mW/ $^\circ\text{C}$ |
| Thermal Resistance,<br>Junction-to-Ambient  | $R_{\theta JA}$ | 556         | $^\circ\text{C}/\text{W}$  |
| Total Device Dissipation<br>Alumina Substrate (Note 2)<br>$T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$           | 300<br>2.4  | mW<br>mW/ $^\circ\text{C}$ |
| Thermal Resistance,<br>Junction-to-Ambient  | $R_{\theta JA}$ | 417         | $^\circ\text{C}/\text{W}$  |
| Junction and Storage Temperature  | $T_J, T_{stg}$  | -55 to +150 | $^\circ\text{C}$           |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
2. Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.



#### MARKING DIAGRAM



- C2 = Specific Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

#### ORDERING INFORMATION

| Device     | Package             | Shipping          |
|------------|---------------------|-------------------|
| BCW30LT1G  | SOT-23<br>(Pb-Free) | 3,000/Tape & Reel |
| SBCW30LT1G | SOT-23<br>(Pb-Free) | 3,000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| Characteristic  | Symbol                      | Min  | Max         | Unit                    |
|---|-----------------------------|------|-------------|-------------------------|
| <b>OFF CHARACTERISTICS</b>  |                             |      |             |                         |
| Collector-Emitter Breakdown Voltage<br>( $I_C = -2.0 \text{ mA}_\text{dc}$ , $I_E = 0$ )  | $V_{(\text{BR})\text{CEO}}$ | -32  | -           | Vdc                     |
| Collector-Emitter Breakdown Voltage<br>( $I_C = -100 \mu\text{A}_\text{dc}$ , $V_{\text{EB}} = 0$ )   | $V_{(\text{BR})\text{CES}}$ | -32  | -           | Vdc                     |
| Collector-Base Breakdown Voltage<br>( $I_C = -10 \mu\text{A}_\text{dc}$ , $I_C = 0$ )   | $V_{(\text{BR})\text{CBO}}$ | -32  | -           | Vdc                     |
| Emitter-Base Breakdown Voltage<br>( $I_E = -10 \mu\text{A}_\text{dc}$ , $I_C = 0$ )   | $V_{(\text{BR})\text{EBO}}$ | -5.0 | -           | Vdc                     |
| Collector Cutoff Current<br>( $V_{\text{CB}} = -32 \text{ Vdc}$ , $I_E = 0$ )<br>( $V_{\text{CB}} = -32 \text{ Vdc}$ , $I_E = 0$ , $T_A = 100^\circ\text{C}$ )                  | $I_{\text{CBO}}$            | -    | -100<br>-10 | nAdc<br>$\mu\text{Adc}$ |
| <b>ON CHARACTERISTICS</b>   |                             |      |             |                         |
| DC Current Gain<br>( $I_C = -2.0 \text{ mA}_\text{dc}$ , $V_{\text{CE}} = -5.0 \text{ Vdc}$ )   | $h_{\text{FE}}$             | 215  | 500         | -                       |
| Collector-Emitter Saturation Voltage<br>( $I_C = -10 \text{ mA}_\text{dc}$ , $I_B = -0.5 \text{ mA}_\text{dc}$ )  | $V_{\text{CE}(\text{sat})}$ | -    | -0.3        | Vdc                     |
| Base-Emitter On Voltage<br>( $I_C = -2.0 \text{ mA}_\text{dc}$ , $V_{\text{CE}} = -5.0 \text{ Vdc}$ )   | $V_{\text{BE}(\text{on})}$  | -0.6 | -0.75       | Vdc                     |
| <b>SMALL-SIGNAL CHARACTERISTICS</b>   |                             |      |             |                         |
| Output Capacitance<br>( $I_E = 0$ , $V_{\text{CB}} = -10 \text{ Vdc}$ , $f = 1.0 \text{ MHz}$ )   | $C_{\text{obo}}$            | -    | 7.0         | pF                      |
| Noise Figure<br>( $I_C = -0.2 \text{ mA}_\text{dc}$ , $V_{\text{CE}} = -5.0 \text{ Vdc}$ , $R_S = 2.0 \text{ k}\Omega$ , $f = 1.0 \text{ kHz}$ , $\text{BW} = 200 \text{ Hz}$ ) | NF                          | -    | 10          | dB                      |

## TYPICAL NOISE CHARACTERISTICS

$(V_{\text{CE}} = -5.0 \text{ Vdc}, T_A = 25^\circ\text{C})$

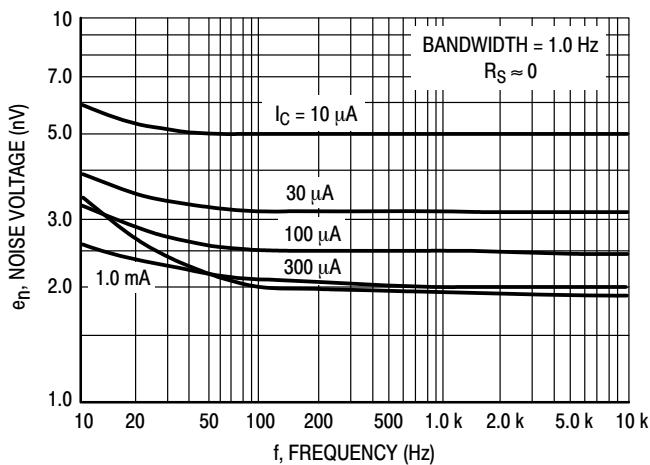


Figure 1. Noise Voltage

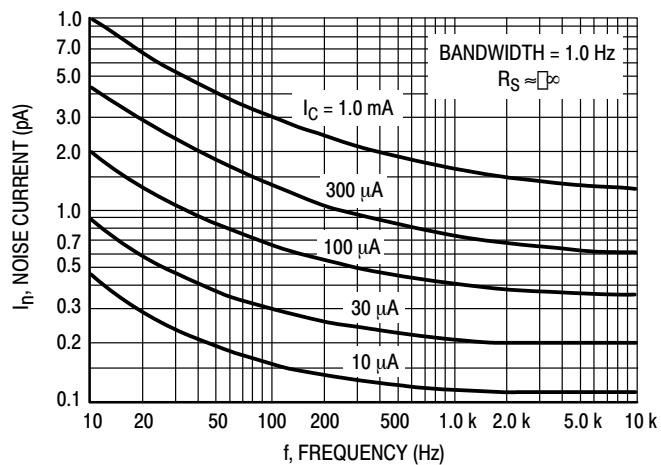
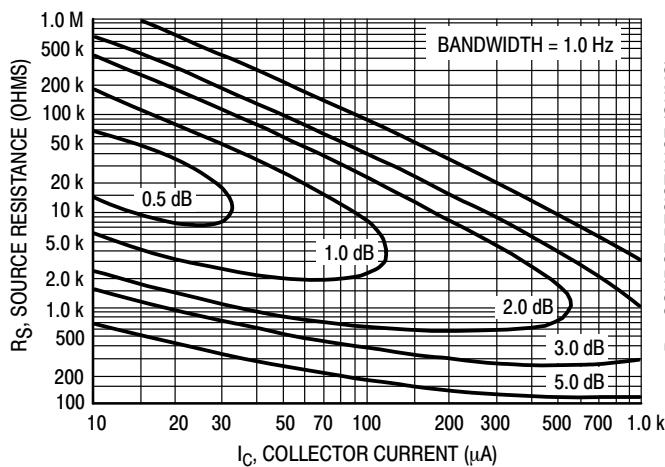


Figure 2. Noise Current

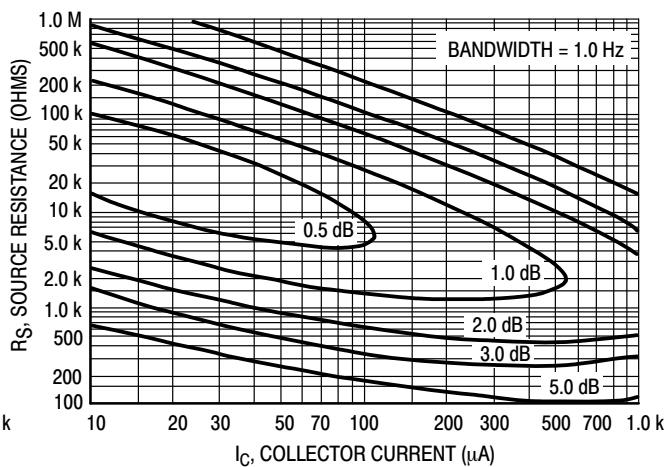
# BCW30LT1G, SBCW30LT1G

## NOISE FIGURE CONTOURS

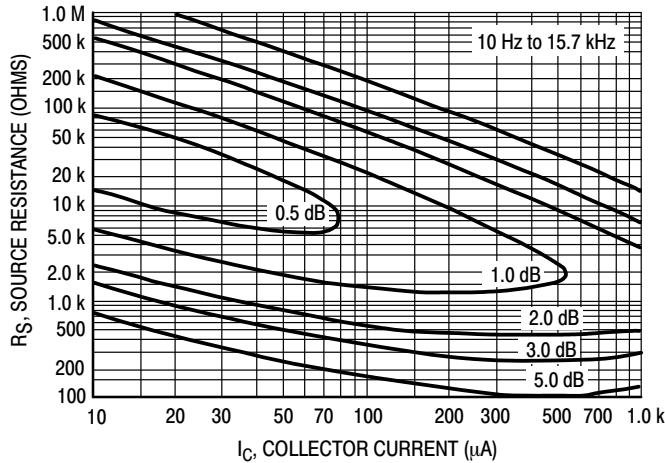
( $V_{CE} = -5.0$  Vdc,  $T_A = 25^\circ\text{C}$ )



**Figure 3. Narrow Band, 100 Hz**



**Figure 4. Narrow Band, 1.0 kHz**



**Figure 5. Wideband**

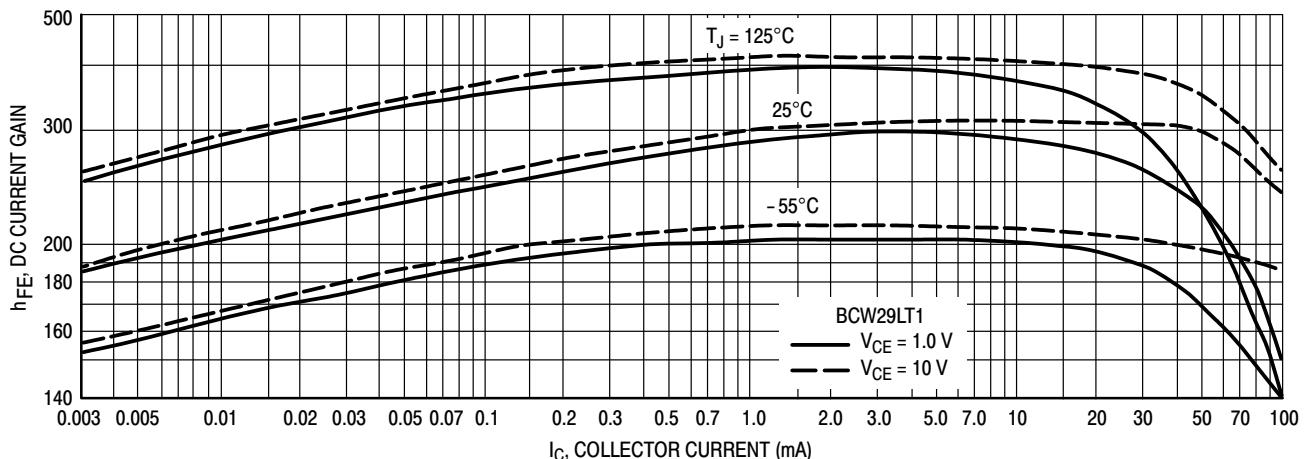
Noise Figure is Defined as:

$$NF = 20 \log_{10} \left[ \frac{e_n^2 + 4KTR_S + I_n^2 R_S^2}{4KTR_S} \right]^{1/2}$$

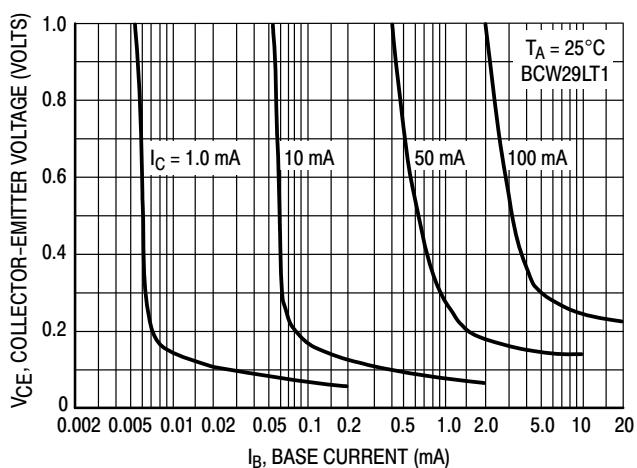
$e_n$  = Noise Voltage of the Transistor referred to the input. (Figure 3)  
 $I_n$  = Noise Current of the Transistor referred to the input. (Figure 4)  
 $K$  = Boltzman's Constant ( $1.38 \times 10^{-23} \text{ J/K}$ )  
 $T$  = Temperature of the Source Resistance ( $^\circ\text{K}$ )  
 $R_S$  = Source Resistance (Ohms)

# BCW30LT1G, SBCW30LT1G

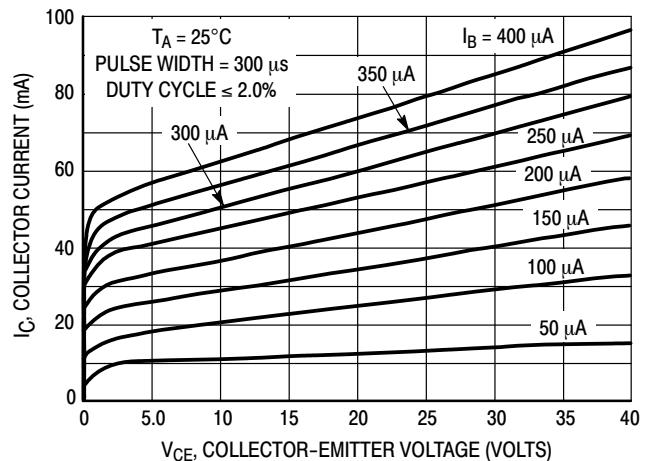
## TYPICAL STATIC CHARACTERISTICS



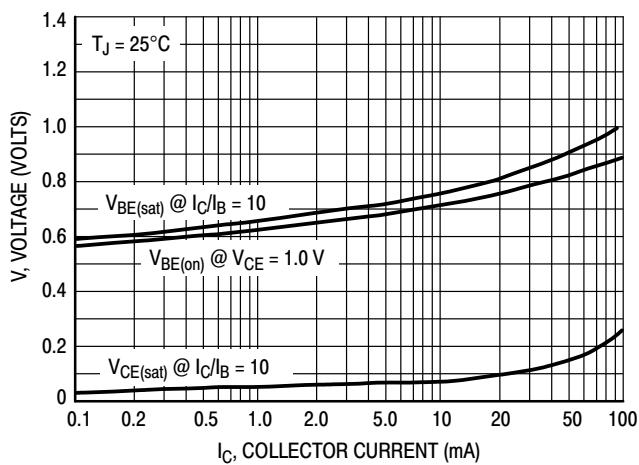
**Figure 6. DC Current Gain**



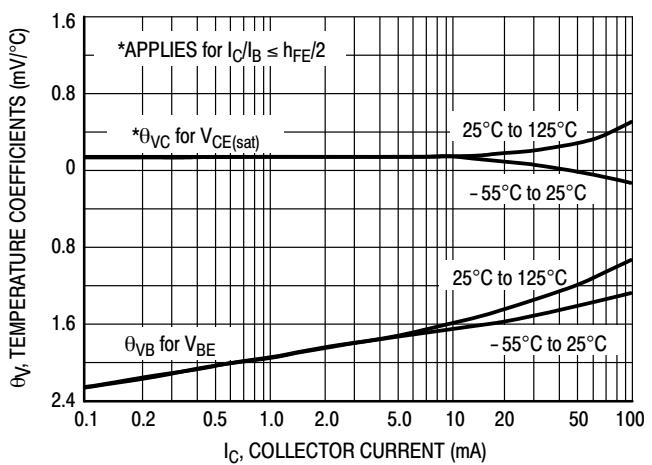
**Figure 7. Collector Saturation Region**



**Figure 8. Collector Characteristics**



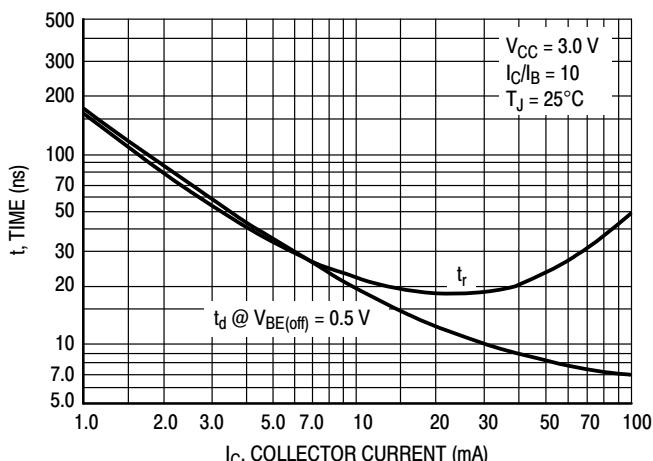
**Figure 9. "On" Voltages**



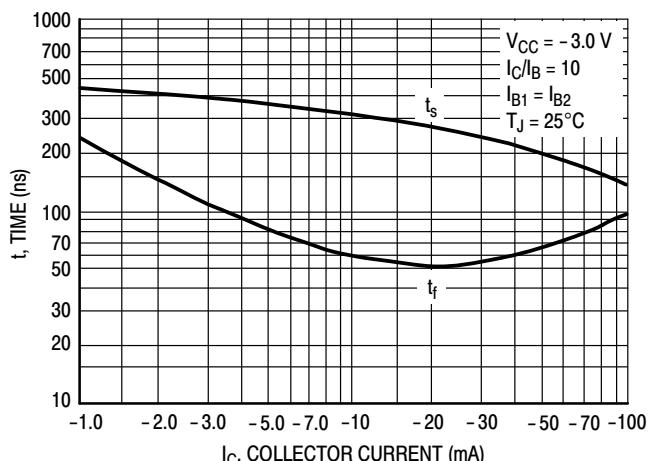
**Figure 10. Temperature Coefficients**

# BCW30LT1G, SBCW30LT1G

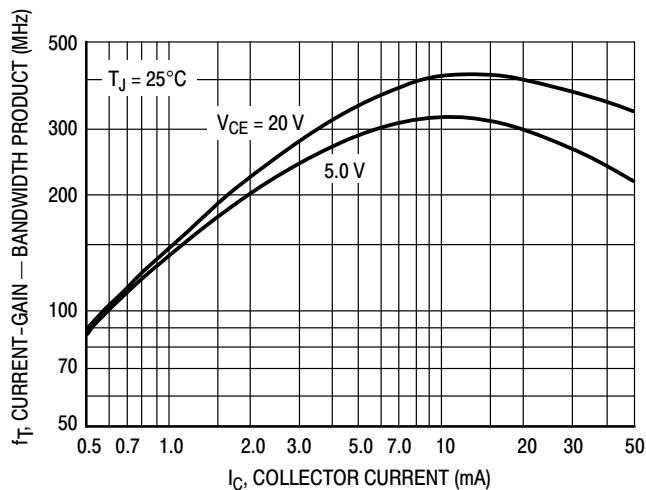
## TYPICAL DYNAMIC CHARACTERISTICS



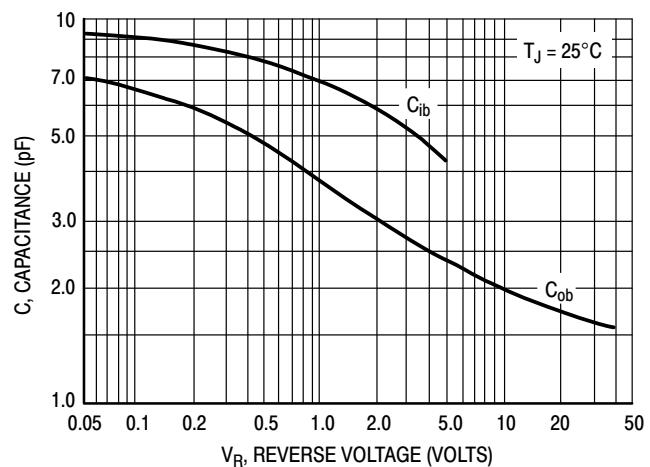
**Figure 11. Turn-On Time**



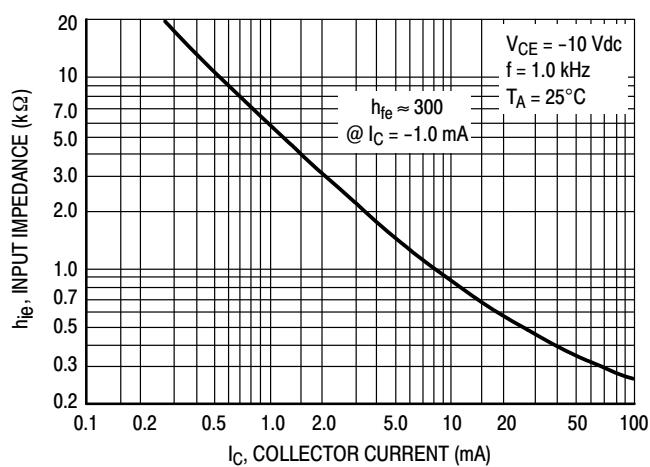
**Figure 12. Turn-Off Time**



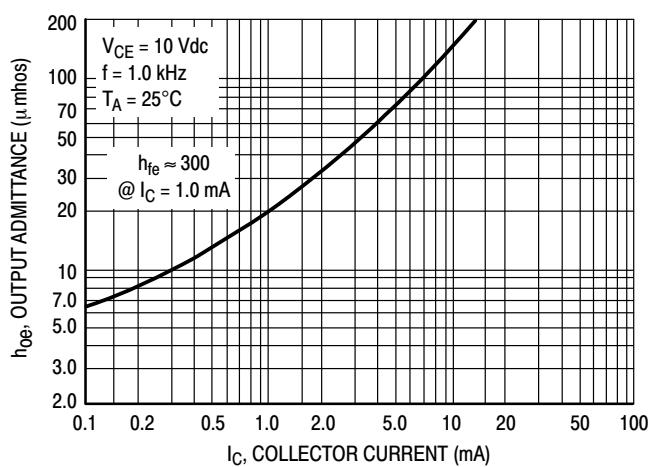
**Figure 13. Current-Gain — Bandwidth Product**



**Figure 14. Capacitance**

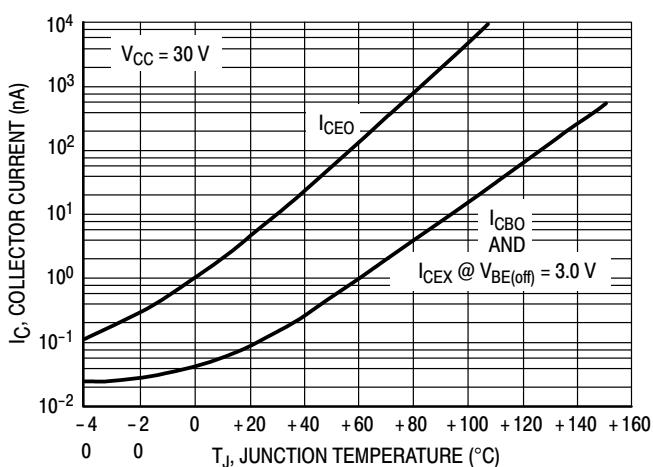
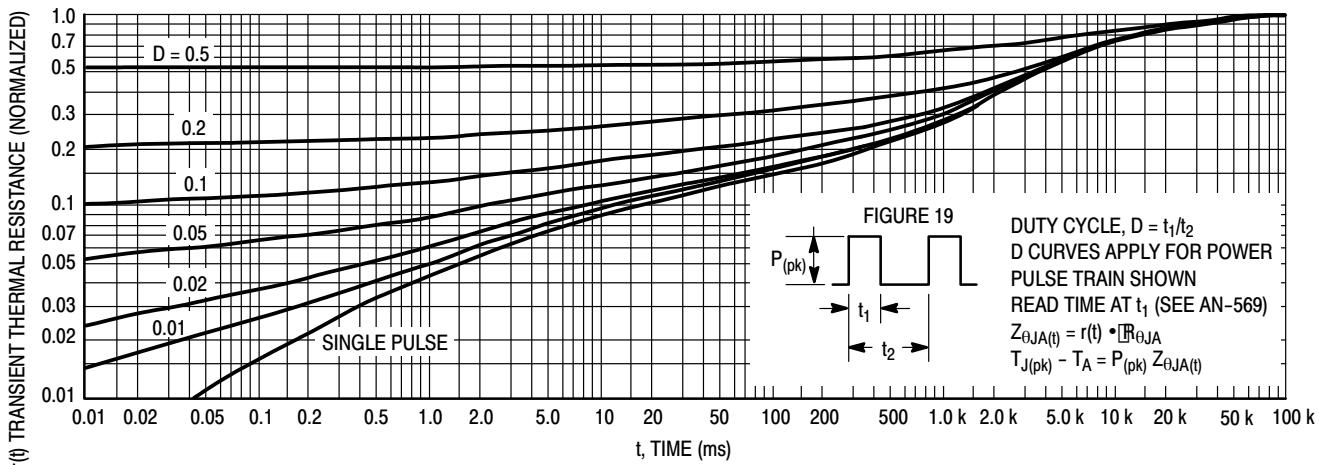


**Figure 15. Input Impedance**



**Figure 16. Output Admittance**

## BCW30LT1G, SBCW30LT1G

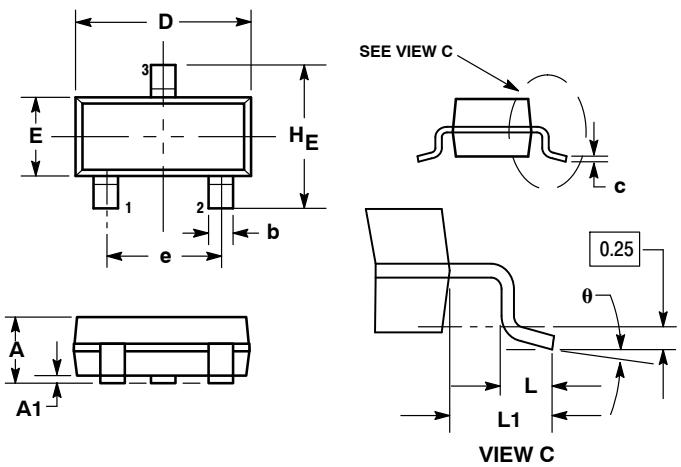


**Figure 18. Typical Collector Leakage Current**

# BCW30LT1G, SBCW30LT1G

## PACKAGE DIMENSIONS

### SOT-23 (TO-236) CASE 318-08 ISSUE AP



#### NOTES:

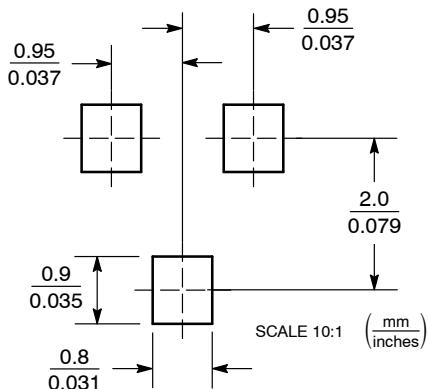
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

| DIM | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
|     | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| A   | 0.89        | 1.00 | 1.11 | 0.035  | 0.040 | 0.044 |
| A1  | 0.01        | 0.06 | 0.10 | 0.001  | 0.002 | 0.004 |
| b   | 0.37        | 0.44 | 0.50 | 0.015  | 0.018 | 0.020 |
| c   | 0.09        | 0.13 | 0.18 | 0.003  | 0.005 | 0.007 |
| D   | 2.80        | 2.90 | 3.04 | 0.110  | 0.114 | 0.120 |
| E   | 1.20        | 1.30 | 1.40 | 0.047  | 0.051 | 0.055 |
| e   | 1.78        | 1.90 | 2.04 | 0.070  | 0.075 | 0.081 |
| L   | 0.10        | 0.20 | 0.30 | 0.004  | 0.008 | 0.012 |
| L1  | 0.35        | 0.54 | 0.69 | 0.014  | 0.021 | 0.029 |
| H_E | 2.10        | 2.40 | 2.64 | 0.083  | 0.094 | 0.104 |
| θ   | 0°          | 10°  | 0°   | ---    | 10°   | ---   |

#### STYLE 6:

- PIN 1. BASE
2. Emitter
3. Collector

## SOLDERING FOOTPRINT



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